



EPW
3725

DOCKET NO. 01-C-055 (STMI01-01055)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Harry M. Siegel, et al.
Serial No.: 10/062,595
Filed: January 31, 2002
For: SYSTEM AND METHOD FOR ALIGNING AN
INTEGRATED CIRCUIT DIE ON AN INTEGRATED
CIRCUIT SUBSTRATE
Group No.: 3725
Examiner: David B. Jones

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT AND RESPONSE TO OFFICE ACTION

In response to the Office Action dated December 28, 2004, please amend the above-identified patent application as follows.